

R6008FNJ

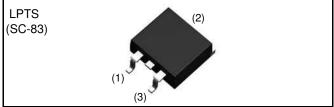
Nch 600V 8A Power MOSFET

V _{DSS}	600V
R _{DS(on)} (Max.)	0.95Ω
I _D	8A
P _D	119W

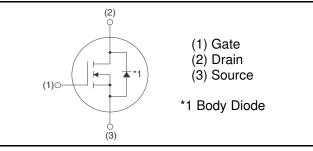
Features

- 1) Low on-resistance.
- 2) Fast switching speed.
- 3) Gate-source voltage (V_{GSS}) guaranteed to be $\pm 30V.$
- 4) Drive circuits can be simple.
- 5) Parallel use is easy.
- 6) Pb-free lead plating ; RoHS compliant

●Outline



Inner circuit



Packaging specifications

Turne	Packaging	Taping
	Reel size (mm)	330
	Tape width (mm)	24
Туре	Basic ordering unit (pcs)	1,000
	Taping code	TL
	Marking	R6008FNJ

Application

Switching Power Supply

•Absolute maximum ratings($T_a = 25^{\circ}C$)

Paramete	Symbol	Value	Unit	
Drain - Source voltage	V _{DSS}	600	V	
Continuous drain current	$T_c = 25^{\circ}C$	I _D ^{*1}	±8	А
	$T_c = 100^{\circ}C$	I _D ^{*1}	±3.9	А
Pulsed drain current	I _{D,pulse} *2	±32	А	
Gate - Source voltage	V _{GSS}	±30	V	
Avalanche energy, single pulse	E _{AS} *3	4.3	mJ	
Avalanche energy, repetitive		E _{AR} ^{*4}	3.4	mJ
Avalanche current		I _{AR} *3	4	А
Power dissipation $(T_c = 25^{\circ}C)$		P _D	119	W
Junction temperature		Tj	150	°C
Range of storage temperature		T _{stg}	-55 to +150	°C
Reverse diode dv/dt		dv/dt *5	15	V/ns

•Absolute maximum ratings

Parameter	Symbol	Conditions	Values	Unit
Drain - Source voltage slope	dv/dt	$V_{DS} = 480V, I_D = 8A$ $T_j = 125^{\circ}C$	50	V/ns

•Thermal resistance

Parameter	Symbol	Values			Unit
Farameter	Symbol	Min.	Тур.	Max.	Unit
Thermal resistance, junction - case	R_{thJC}	-	-	1.05	°C/W
Thermal resistance, junction - ambient	R _{thJA}	-	-	80	°C/W
Soldering temperature, wavesoldering for 10s	T_{sold}	-	-	265	°C

•Electrical characteristics($T_a = 25^{\circ}C$)

Parameter	Symbol	Conditions	Values			Unit	
Faranielei	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Drain - Source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 1mA$	600	-	-	V	
Drain - Source avalanche breakdown voltage	$V_{(BR)DS}$	$V_{GS} = 0V, I_D = 8A$	-	700	-	V	
Zero gate voltage drain current	I _{DSS}	$V_{DS} = 600V, V_{GS} = 0V$ $T_j = 25^{\circ}C$ $T_j = 125^{\circ}C$	-	1	100 10	μA mA	
Gate - Source leakage current	I _{GSS}	$V_{GS} = \pm 30V, V_{DS} = 0V$			±100	nA	
Gate threshold voltage	V _{GS (th)}	$V_{DS} = 10V, I_D = 1mA$	2.0	-	4.0	V	
Static drain - source on - state resistance	$R_{DS(on)}$ *6	$V_{GS} = 10V, I_D = 4A$ $T_j = 25^{\circ}C$ $T_j = 125^{\circ}C$	-	0.73 1.62	0.95	Ω	
Gate input resistance	R_G	f = 1MHz, open drain	-	8.0	-	Ω	

•Electrical characteristics($T_a = 25^{\circ}C$)

Deremeter	Cumbal	Conditions		Unit			
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Transconductance	g _{fs} *6	$V_{DS} = 10V, I_{D} = 4.0A,$	2.5	5.0	-	S	
Input capacitance	C _{iss}	$V_{GS} = 0V$	-	580	-		
Output capacitance	C _{oss}	$V_{DS} = 25V$	-	450	-	pF	
Reverse transfer capacitance	C _{rss}	f = 1MHz	-	25	-		
Effective output capacitance, energy related	$C_{o(er)}$	V _{GS} = 0V	-	31.5	-	-	
Effective output capacitance, time related	C _{o(tr)}	$V_{DS} = 0V$ to 480V	-	31.8	-	pF	
Turn - on delay time	t _{d(on)} *6	$V_{DD} \simeq 300V, V_{GS} = 10V$	-	20	-		
Rise time	t _r *6	$I_D = 4A$	-	25	-	20	
Turn - off delay time	t _{d(off)} *6	$R_L = 75\Omega$	-	60	120	ns	
Fall time	t _f *6	$R_G = 10\Omega$	-	30	60		

•Gate Charge characteristics($T_a = 25^{\circ}C$)

Deremeter	Symbol	Conditions	Values			Unit
Parameter	Symbol Conditions -		Min.	Тур.	Max.	Offic
Total gate charge	Q_{g}^{*6}	$V_{DD} \simeq 300 V$	-	20	-	
Gate - Source charge	${\sf Q_{gs}}^{*6}$	I _D = 8A	-	5	-	nC
Gate - Drain charge	${\sf Q}_{\sf gd}$ *6	$V_{GS} = 10V$	-	10	-	
Gate plateau voltage	V _(plateau)	$V_{DD} \simeq 300V, \ I_D = 8A$	-	5.7	-	V

*1 Limited only by maximum temperature allowed.

*2 Pw \leq 10 $\mu s,$ Duty cycle \leq 1%

*3 L \simeq 500µH, V_{DD} = 50V, R_G = 25\Omega, starting T_j = 25°C

*4 L \simeq 500µH, V_{DD} = 50V, R_G = 25\Omega, starting T_j = 25°C, f = 10kHz

*5 Reference measurement circuits Fig.5-1.

*6 Pulsed

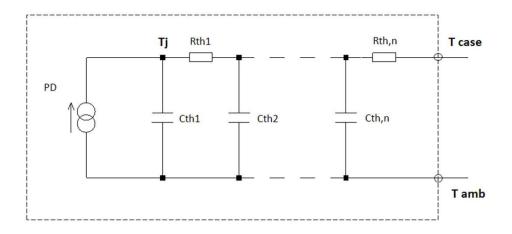
R6008FNJ

•Body diode electrical characteristics (Source-Drain)($T_a = 25^{\circ}C$)

Parameter	Symbol Conditions			Unit			
Faranielei	Symbol	Conditions	Min.	Тур.	Max.	UTIIL	
Inverse diode continuous, forward current	I_S^{*1}	T _c = 25°C	-	-	8	А	
Inverse diode direct current, pulsed	I _{SM} *2	T _c = 25 0	-	-	32	А	
Forward voltage	V_{SD} *6	$V_{GS} = 0V, I_S = 8A$	-	-	1.5	V	
Reverse recovery time	t _{rr} *6		-	67	-	ns	
Reverse recovery charge	Q _{rr} ^{*6}	I _S = 8A di/dt = 100A/us	-	0.17	-	μC	
Peak reverse recovery current	^{*6}		-	4.9	-	А	
Peak rate of fall of reverse recovery current	di _{rr} /dt	T _j = 25°C	-	610	-	A/µs	

•Typical Transient Thermal Characteristics

Symbol	Value	Unit	Symbol	Value	Unit
R _{th1}	0.118		C _{th1}	0.0014	
R _{th2}	0.472	K/W	C _{th2}	0.00402	Ws/K
R _{th3}	0.583		C_{th3}	0.174	



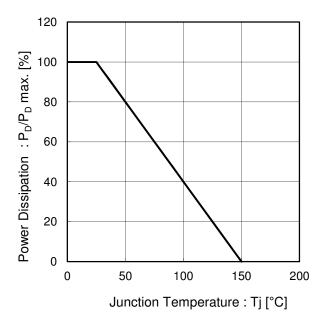
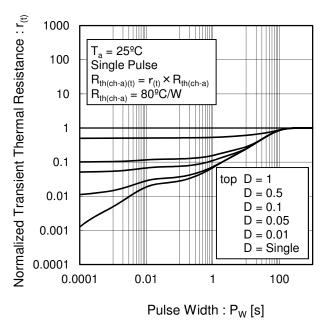


Fig.1 Power Dissipation Derating Curve

100 Operation in this 10 area is limited by R_{DS(ON)} Drain Current : I_D [A] $P_W = 100us$ 1 $P_W = 1ms$ 0.1 $P_W = 10ms$ = 25ºC T_ Single Pulse 0.01 10 1000 0.1 1 100 Drain - Source Voltage : V_{DS} [V]

Fig.2 Maximum Safe Operating Area

Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width



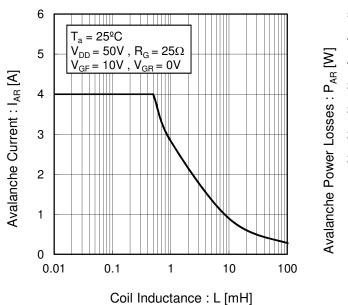


Fig.4 Avalanche Current vs Inductive Load

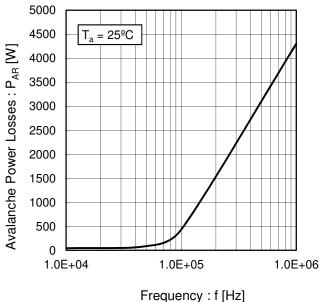
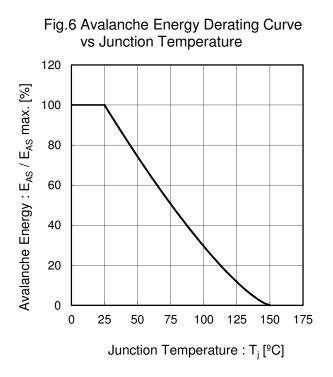
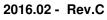


Fig.5 Avalanche Power Losses



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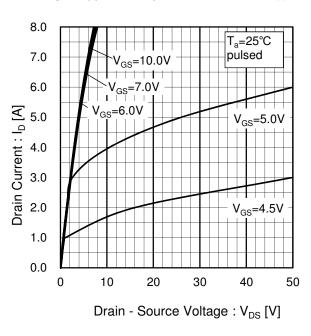
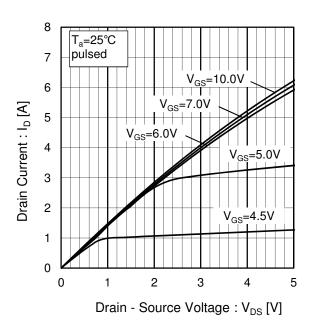
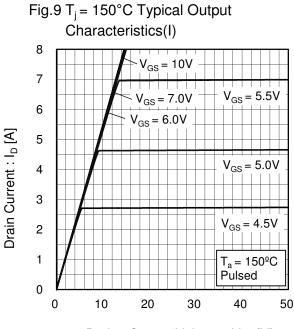


Fig.7 Typical Output Characteristics(I)

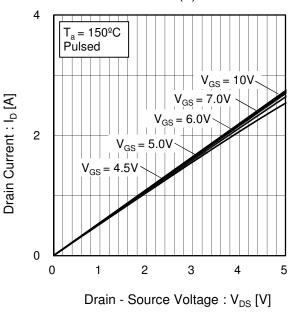
Fig.8 Typical Output Characteristics(II)

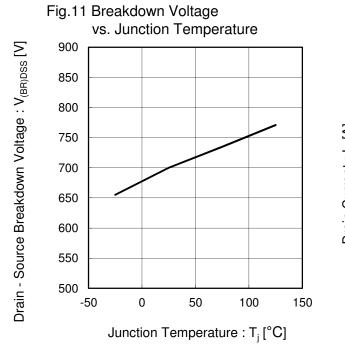




Drain - Source Voltage : V_{DS} [V]

Fig.10 T_j = 150°C Typical Output Characteristics(II)





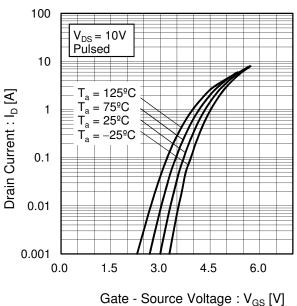


Fig.12 Typical Transfer Characteristics

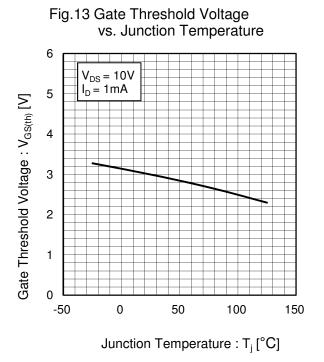
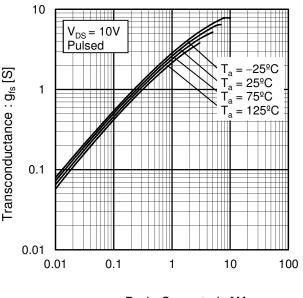


Fig.14 Transconductance vs. Drain Current



Drain Current : I_D [A]

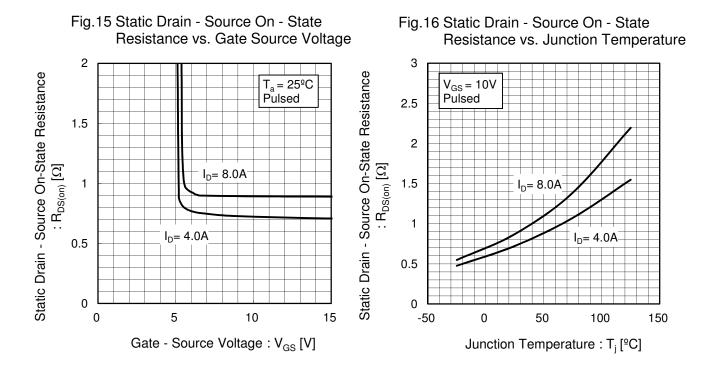
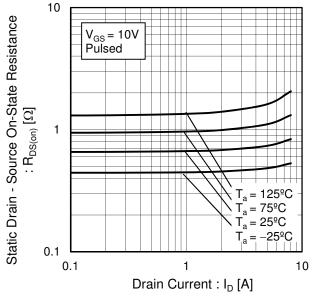


Fig.17 Static Drain - Source On - State Resistance vs. Drain Current





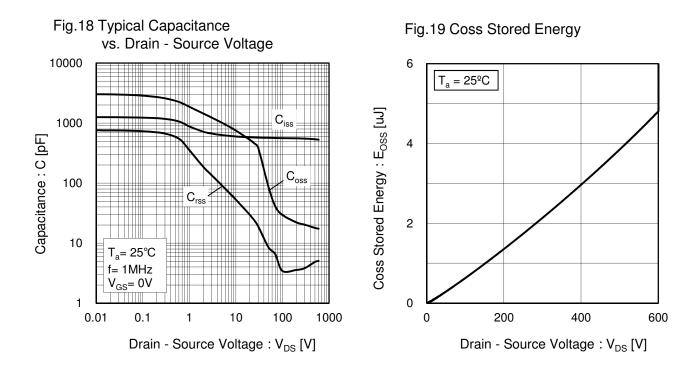
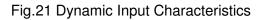
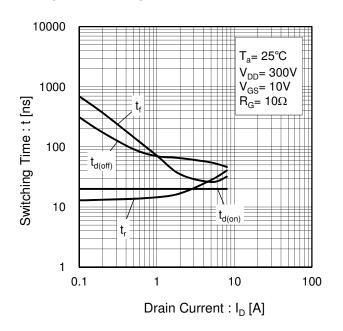
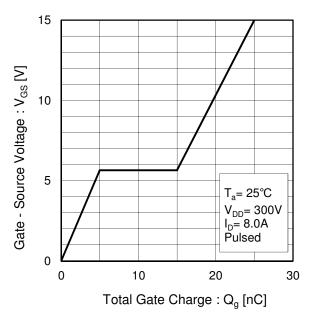
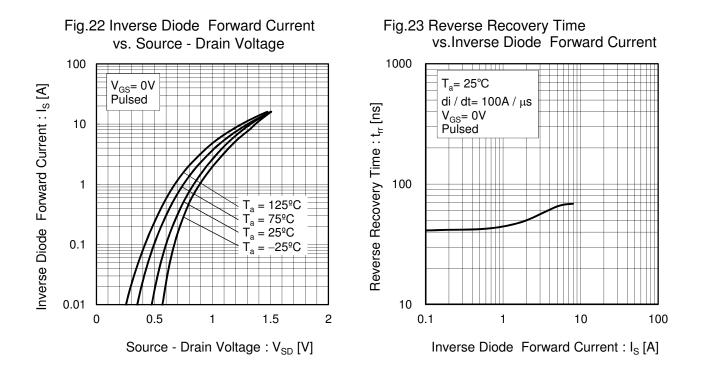


Fig.20 Switching Characteristics









Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

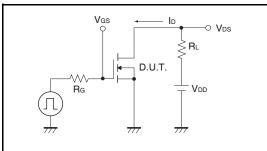


Fig.2-1 Gate Charge Measurement Circuit

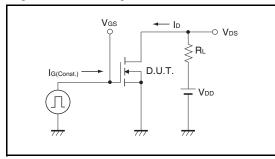


Fig.3-1 Avalanche Measurement Circuit

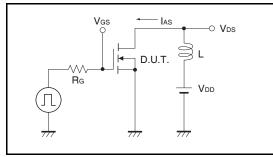


Fig.4-1 dv/dt Measurement Circuit

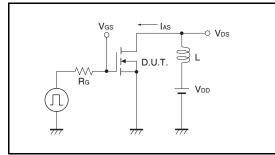


Fig.5-1 di/dt Measurement Circuit

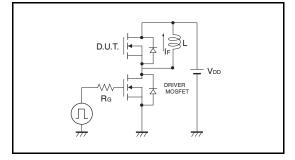


Fig.1-2 Switching Waveforms

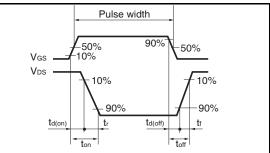


Fig.2-2 Gate Charge Waveform

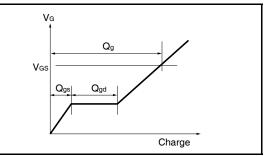


Fig.3-2 Avalanche Waveform

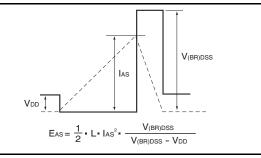


Fig.4-2 dv/dt Waveform

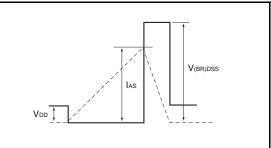
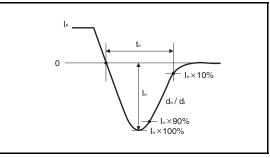
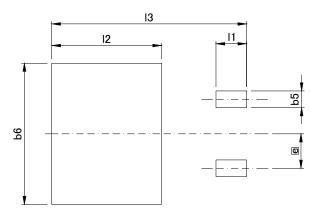


Fig.5-2 di/dt Waveform



•Dimensions (Unit : mm) D A2 Α В c1 2 LPTS പ ш Ϊ A1 b2 9 b3 <u>b</u> ⊕ x∭ B A е c A3



Patterm of terminal position areas

		ETEDS	INC		
DIM		ETERS	INC		
	MIN	MAX	MIN	MAX	
A1	0.00	0.30	0	0.012	
A2	4.30	4.70	0.169	0.185	
A3	0.3	25	0.0	01	
b	0.68	0.98	0.027	0.039	
b2	8.	90	0.3	35	
b3	1.14	1.44	0.045	0.057	
с	0.30	0.60	0.012	0.024	
c1	1.10	1.50	0.043	0.059	
D	9.80	10.40	0.386	0.409	
E	8.80	9.20	0.346	0.362	
е	2.	54	0.10		
HE	12.80	13.40	0.504	0.528	
L	2.70	3.30	0.106	0.13	
L1	0.90	1.50	0.035	0.059	
L2	1.10		0.0	43	
L3	7.25		0.285		
L4	1.00		0.0	39	
Lp	0.90	1.50	0.035	0.059	
x	-	0.25	-	0.01	

DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
b5	I	1.23	-	0.049
b6	1	10.40	-	0.409
1	-	2.10	-	0.083
12	-	7.55	-	0.297
13	-	13.40	-	0.528

Dimension in mm/inches

Notice

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(Note1) Medical Equipment Classification of	the Specific Applications
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JAPAN	USA	EU	CHINA
CLASSⅢ	CLASSⅢ	CLASS II b	CLASSⅢ
CLASSⅣ	CLASSII	CLASSⅢ	CLASSI

- 2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:
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 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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